

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:	)	
	)	
Appl. No. : 10/823,970	)	Confirmation No. 5318
Applicant : OGAWA, et al.	)	
Filed : 13 April 2004	)	
Art Unit : 2818	)	
Examiner : Hoang, Quoc Dinh	)	
Attorney :	)	
Docket No. : SPSN-AF01215	)	
	)	
For: SEMICONDUCTOR DEVICE HAVING	)	
A PAD METAL LAYER AND A LOWER METAL	)	
LAYER THAT ARE ELECTRICALLY	)	
COUPLED, WHEREAS APERTURES ARE	)	
FORMED IN THE LOWER METAL LAYER	)	
BELOW A CENTER AREA OF THE PAD	)	
METAL LAYER	)	
	)	

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

AMENDMENT AND RESPONSE AND TO OFFICE ACTION

Dear Sir:

In response to the Office Action dated April 4, 2008, Applicants respectfully request reconsideration of the above-identified patent application. Please consider the following amendments and remarks for allowance of the above-identified patent application. Immediately after this transmittal page are Amendments to the Claims, included in a complete listing of the claims, followed by Applicant Argument (or Remarks).

I hereby certify that this  
correspondence is being  
electronically transmitted to the  
USPTO via EFS on the date shown  
below:  
July 7<sup>th</sup>, 2008  
/Christina Holland/  
Christina Holland